

S/N 09/733,289

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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| Applicant: | Xiao-Chun Mu et al. | Examiner: | DiLinh Nguyen |
| Serial No.: | 09/733,289 | Group Art Unit: | 2814 |
| Filed: | December 8, 2000 | Docket No: | 884.798US1 |
| Title | Microelectronic Package Having an Integrated Heat Sink and Build-Up Layers | | |
| Customer Number: | 21186 | | |

PETITION FOR A THREE-MONTH EXTENSION OF TIME

MS RCE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

In accordance with the provision of 37 CFR § 1.136(a), it is respectfully requested that a three-month extension of time be granted in which to respond to the Final Office Action mailed October 30, 2007, said period of response being extended from January 30, 2008 to April 30, 2008.

Please charge Deposit Account No. 19-0743 in the amount of \$1050.00 to cover the required extension fee. Please charge any additional fees or credit overpayment to deposit Account No. 19-0743.

Respectfully Submitted

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By: _____


John N. Greaves
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